



PQMH10

NPN/NPN resistor-equipped transistors;
 $R1 = 2.2 \text{ k}\Omega$, $R2 = 47 \text{ k}\Omega$

15 April 2025

Product data sheet

1. General description

NPN/NPN Resistor-Equipped Transistors (RET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package.

NPN/PNP complement: PQMD10

2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Low package height of 0.37 mm
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

3. Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications
- Mobile applications

4. Quick reference data

Table 1. Quick reference data

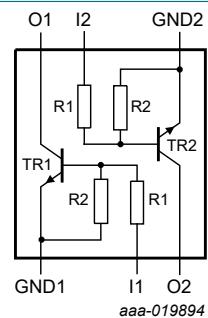
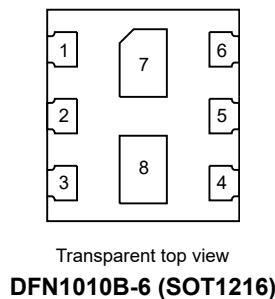
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
V_{CEO}	collector-emitter voltage	open base		-	-	50	V
I_o	output current			-	-	100	mA
R1	bias resistor 1 (input)	$T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	1.54	2.2	2.86	k Ω
R2/R1	bias resistor ratio		[1]	17	21	26	

[1] See section "Test information" for resistor calculation and test conditions.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	GND1	GND (emitter) TR1		
2	I1	input (base) TR1		
3	O2	output (collector) TR2		
4	GND2	GND (emitter) TR2		
5	I2	input (base) TR2		
6	O1	output (collector) TR1		
7	O1	output (collector) TR1		
8	O2	output (collector) TR2		



6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PQMH10	DFN1010B-6	plastic, leadless thermal enhanced ultra thin small outline package; 6 terminals; 0.35 mm pitch; 1.1 mm x 1 mm x 0.37 mm body	SOT1216

7. Marking

Table 4. Marking codes

Type number	Marking code
PQMH10	A 011

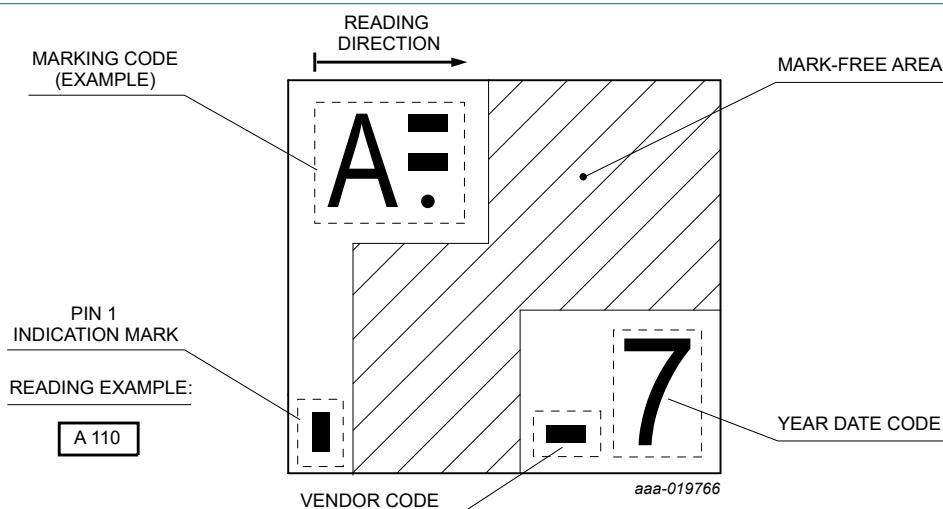


Fig. 1. DFN1010B-6 (SOT1216) binary marking code description

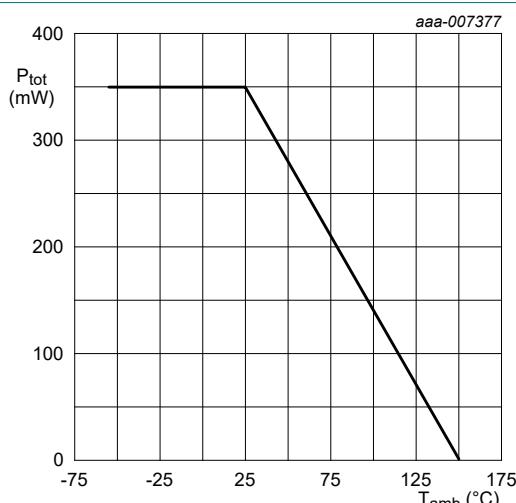
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transistor						
V_{CBO}	collector-base voltage	open emitter		-	50	V
V_{CEO}	collector-emitter voltage	open base		-	50	V
V_{EBO}	emitter-base voltage	open collector		-	5	V
V_I	input voltage	positive		-	12	V
		negative		-	-5	V
I_O	output current			-	100	mA
I_{CM}	peak collector current			-	100	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25 \text{ }^{\circ}\text{C}$	[1]	-	230	mW
Per device						
P_{tot}	total power dissipation	$T_{amb} \leq 25 \text{ }^{\circ}\text{C}$	[1]	-	350	mW
T_j	junction temperature			-	150	$^{\circ}\text{C}$
T_{amb}	ambient temperature			-55	150	$^{\circ}\text{C}$
T_{stg}	storage temperature			-65	150	$^{\circ}\text{C}$

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

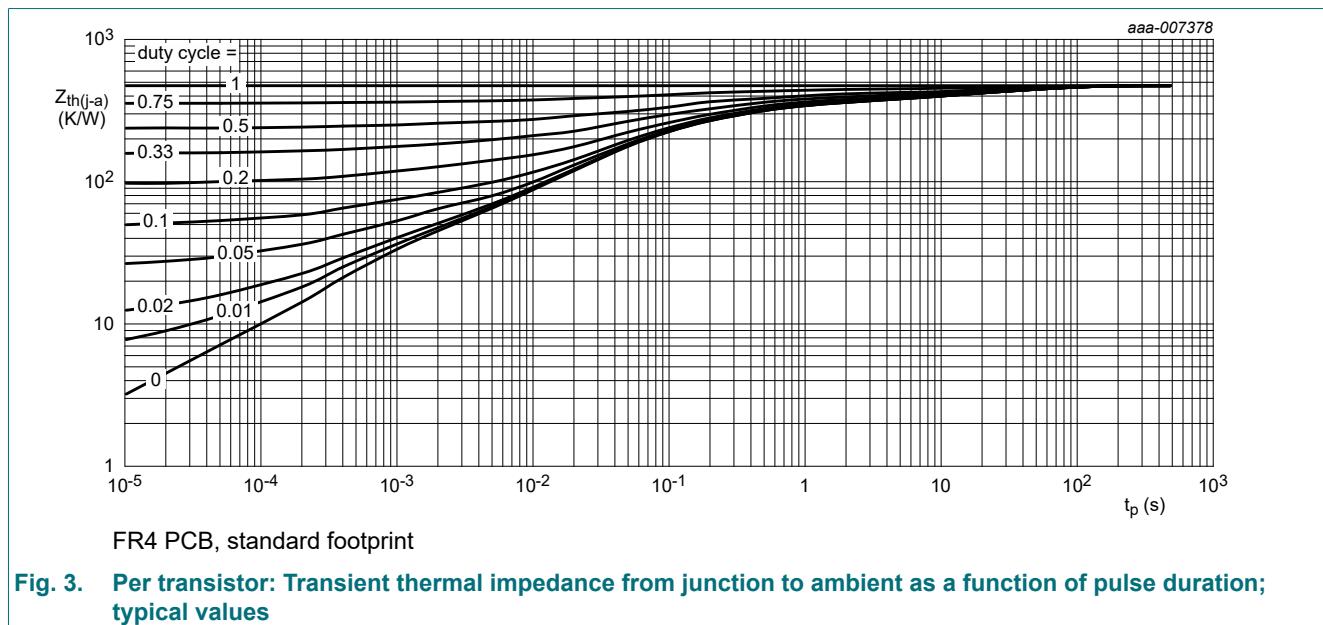
Fig. 2. Per device: Power derating curve

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	543	K/W
Per device							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	357	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



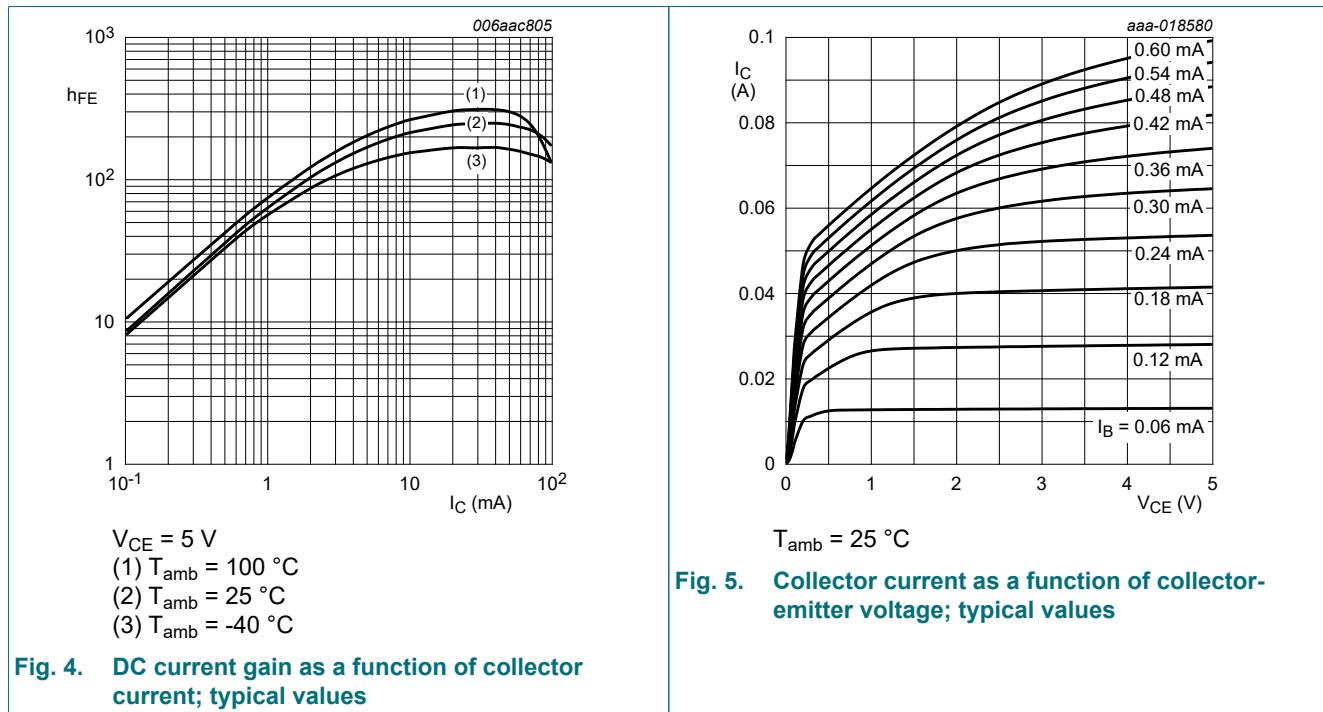
10. Characteristics

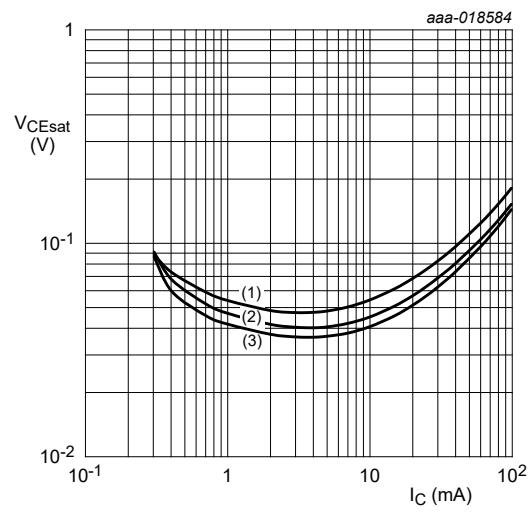
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
I_{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}$; $I_E = 0 \text{ A}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	100	nA
I_{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$; $I_B = 0 \text{ A}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	1	μA
		$V_{CE} = 30 \text{ V}$; $I_B = 0 \text{ A}$; $T_{amb} = 150 \text{ }^\circ\text{C}$		-	-	5	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}$; $I_C = 0 \text{ A}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	180	μA
h_{FE}	DC current gain	$V_{CE} = 5 \text{ V}$; $I_C = 10 \text{ mA}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		100	-	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 5 \text{ mA}$; $I_B = 0.25 \text{ mA}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	100	mV
$V_{I(off)}$	off-state input voltage	$V_{CE} = 5 \text{ V}$; $I_C = 100 \text{ }\mu\text{A}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	0.6	0.5	V
$V_{I(on)}$	on-state input voltage	$V_{CE} = 0.3 \text{ V}$; $I_C = 5 \text{ mA}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		1.1	0.75	-	V
$R1$	bias resistor 1 (input)	$T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	1.54	2.2	2.86	$\text{k}\Omega$
$R2/R1$	bias resistor ratio		[1]	17	21	26	
C_c	collector capacitance	$V_{CB} = 10 \text{ V}$; $I_E = 0 \text{ A}$; $f = 1 \text{ MHz}$; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	2.5	pF
f_T	transition frequency	$V_{CE} = 5 \text{ V}$; $I_C = 10 \text{ mA}$; $f = 100 \text{ MHz}$; $T_{amb} = 25 \text{ }^\circ\text{C}$	[2]	-	230	-	MHz

[1] See section "Test information" for resistor calculation and test conditions.

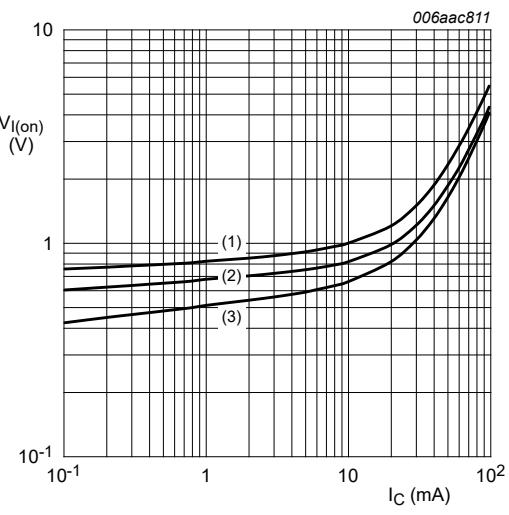
[2] Characteristics of built-in transistor





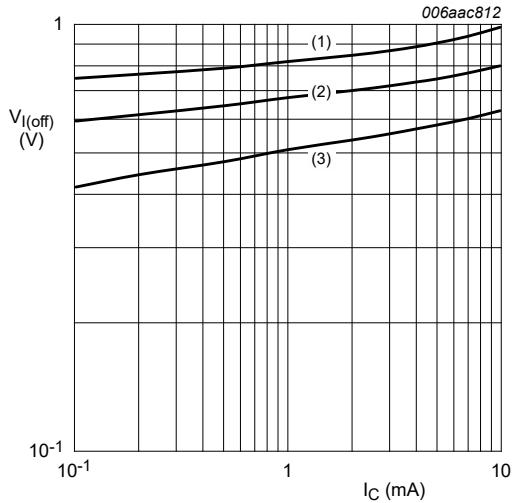
$I_C/I_B = 20$
 (1) $T_{\text{amb}} = 100 \text{ }^{\circ}\text{C}$
 (2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$
 (3) $T_{\text{amb}} = -40 \text{ }^{\circ}\text{C}$

Fig. 6. Collector-emitter saturation voltage as a function of collector current; typical values



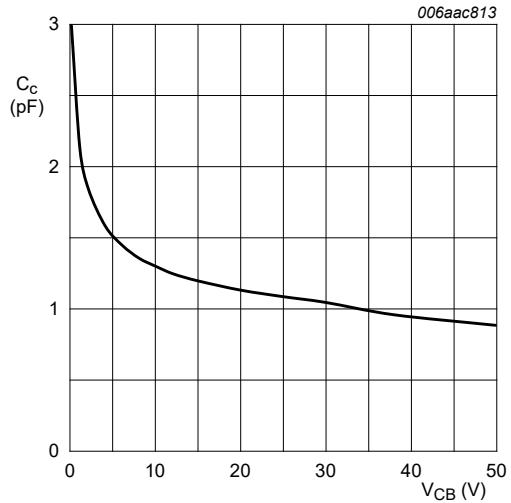
$V_{CE} = 0.3 \text{ V}$
 (1) $T_{\text{amb}} = -40 \text{ }^{\circ}\text{C}$
 (2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$
 (3) $T_{\text{amb}} = 100 \text{ }^{\circ}\text{C}$

Fig. 7. On-state input voltage as a function of collector current; typical values



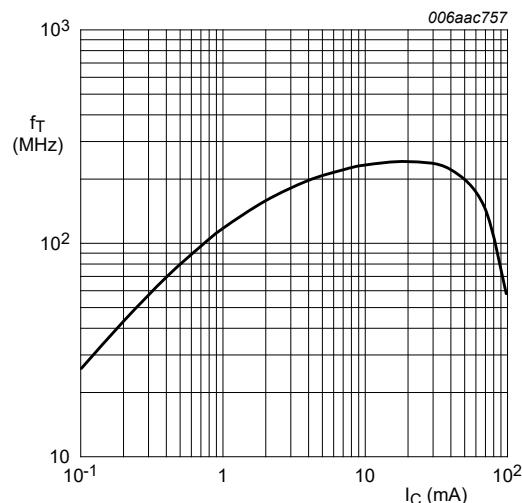
$V_{CE} = 5 \text{ V}$
 (1) $T_{\text{amb}} = -40 \text{ }^{\circ}\text{C}$
 (2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$
 (3) $T_{\text{amb}} = 100 \text{ }^{\circ}\text{C}$

Fig. 8. Off-state input voltage as a function of collector current; typical values



$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$

Fig. 9. Collector capacitance as a function of collector-base voltage; typical values



$V_{CE} = 5 \text{ V}$; $T_{amb} = 25 \text{ }^{\circ}\text{C}$

Fig. 10. Transition frequency as a function of collector current; typical values of built-in transistor

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R1 = \frac{V(I_{I2}) - V(I_{II})}{I_{I2} - I_{II}}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R2}{R1} = \frac{V(I_4) - V(I_3)}{R1 \cdot (I_4 - I_3)} - 1$$

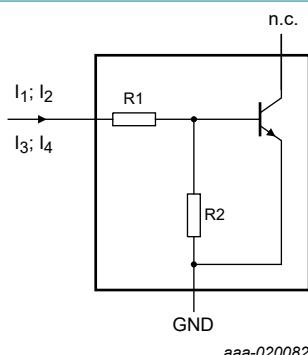


Fig. 11. Per transistor: Resistor test circuit

Resistor test conditions

Table 8. Resistor test conditions

R1 (kΩ)	R2 (kΩ)	Test conditions			
		I _{I1}	I _{I2}	I _{I3}	I _{I4}
2.2	47	90 µA	140 µA	-55 µA	-105 µA

12. Package outline

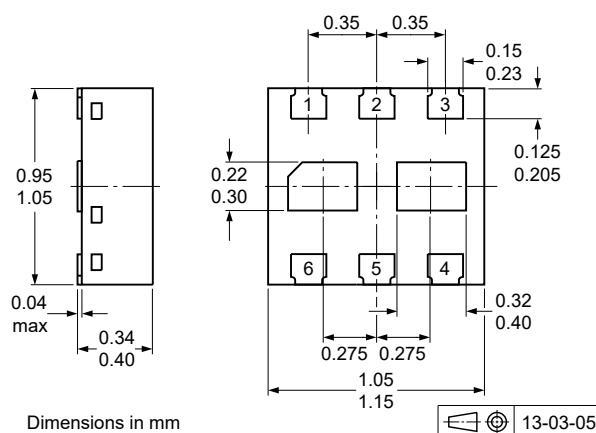
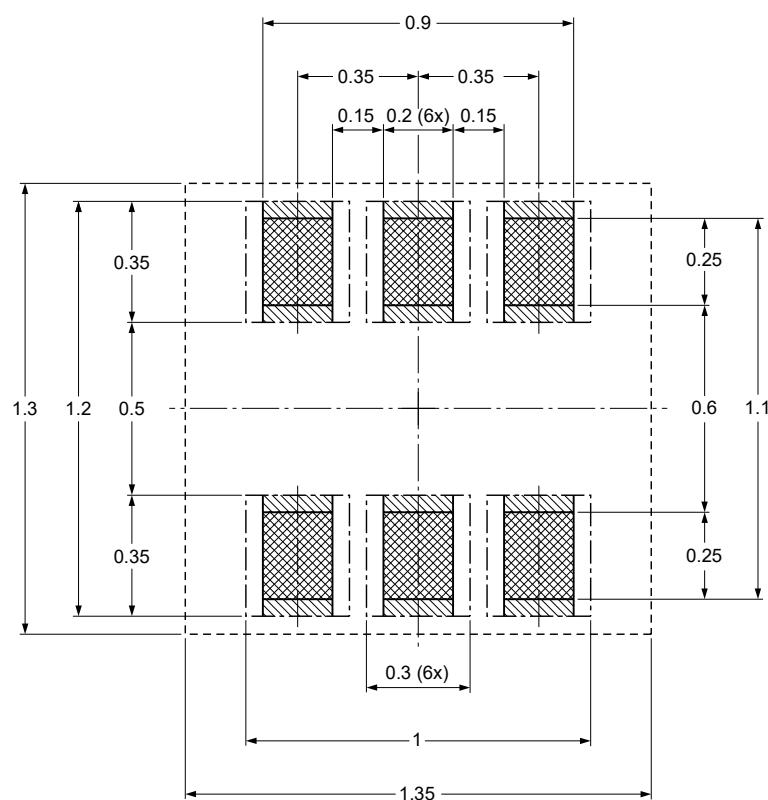


Fig. 12. Package outline DFN1010B-6 (SOT1216)

13. Soldering

Footprint information for reflow soldering of DFN1010B-6 package

SOT1216



solder paste



solder land plus solder paste



occupied area



solder resist

Dimensions in mm

Issue date 14-07-28
17-03-31

sot1216_fr

Fig. 13. Reflow soldering footprint for DFN1010B-6 (SOT1216)

14. Revision history

Table 9. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PQMH10 v.2	20250415	Product data sheet	-	PQMH10 v.1
Modifications:	• Soldering changed			
PQMH10 v.1	20151104	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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